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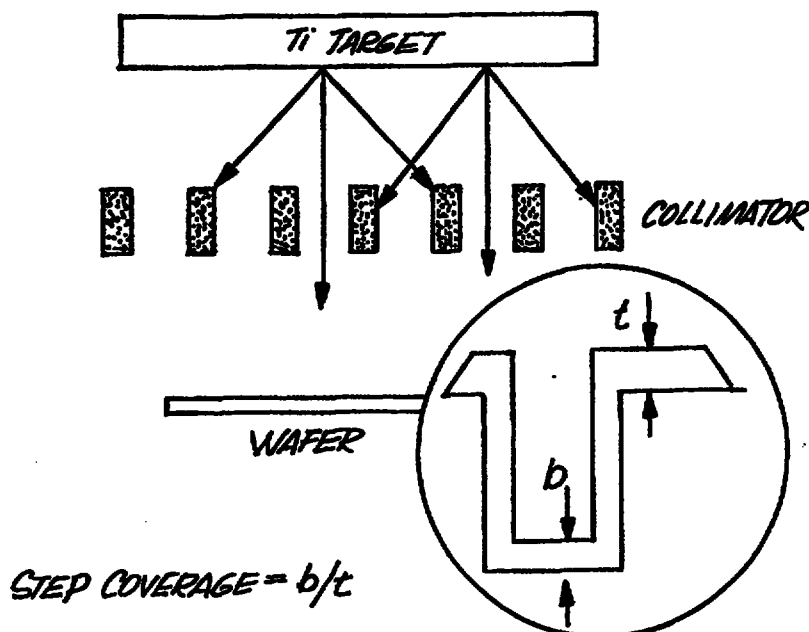
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(54) Title: TITANIUM SPUTTERING TARGET AND METHOD OF MANUFACTURE



(57) Abstract

Described is a titanium sputtering target to provide improved step coverage and a method of making same.